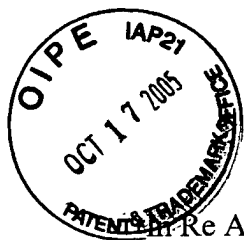


IFW



Attorney Docket 0553-0166.01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Re Application of)
)
Yamazaki et al.)
)
Serial No.: 10/629,069)
)
Filed: July 29, 2003)
)
For: Wiring Material And A)
Semiconductor Device Having A)
Wiring Using the Material, And The)
Manufacturing Method Thereof)
)
Art Unit: 2826)
)
Examiner: Fetsum Abraham)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to:
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October 13, 2005

(Date of Deposit)

Shannon Wallace

Name of applicant, assignee, or Registered Rep.

Shannon Wallace 10/13/05

Signature

Date

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT D

Sir:

In response to the Office Action mailed July 13, 2005, please amend the above-identified application as follows: